

06-24-2004

A/O 581-40

10/485019

RECORDATION FORM COVER SHEET

PATENTS ONLY

OT12 Rec'd PCT/PTO 23 JAN 2004



102776004

FOR PATENTS: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies): (If multiple assignors, list numerically)

- (1) Mitsuyoshi SHIRAI (2) Natsuko OKUMURA
- (3) Michirou KAWANISHI

Additional name(s) of conveying party(ies) attached?
() Yes (X) No

2. Name and address of receiving party(ies):

Name: NITTO DENKO CORPORATION 1-28-04
 Address: 1-1-2, Shimohozumi, Ibaraki-shi
 Osaka, 567-8680 JAPAN

Additional name(s) of receiving party(ies) attached?
() Yes (X) No

3. Nature of conveyance:

- (X) Assignment
- () Merger
- () Security Agreement
- () Change of Name
- () Other:

Execution Date: (If multiple assignors, list execution dates in numerical order corresponding to numbers indicated in 1 above) All executed on 01/20/04.

4. Application number(s) or Patent number(s):

- (X) Application(s) filed herewith
Execution Date(s): January 20, 2004
- () Patent Application No.:
Filing Date:
- () Patent No.:
Issue Date:

Additional numbers attached? () Yes (X) No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Daniel E. Altman
 KNOBBE, MARTENS, OLSON & BEAR, LLP
 Customer No. 20,995
 Internal Address: Fourteenth Floor
 Street Address: 2040 Main Street
 City: Irvine State: CA ZIP: 92614
 Attorney's Docket No.: UNIU79.018APC

7. Total fee (37 CFR 1.21(h)): \$40
 (X) Enclosed
 () Authorized to be charged to deposit account

8. Deposit account number: 11-1410

Please charge this account for any additional fees which may be required, or credit any overpayment to this account.

6. Total number of applications and patents involved: 1

9. Statement and signature.

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To the best of my knowledge and belief, the foregoing information is true and correct, and any attached copy is a true copy of the original document.

Katsuhiro Arai
Name of Person Signing

Signature

January 28, 2004
Date

43,315
Registration No.

Total number of pages including cover sheet, attachments and document: 3

Mail documents to be recorded with required cover sheet information to:

Mail Stop Assignment Recordation Services
 Director, U.S. Patent and Trademark Office
 P.O. Box 1450
 Alexandria, VA 22313-1450

H:\DOCS\KOA\KOA-1264.DOC
012704

Application No.:
Filing Date:

ASSIGNMENT

WHEREAS, We, Mitsuyoshi SHIRAI, a Japanese citizen, residing at 1-1-2, Shimohozumi, Ibaraki-shi, Osaka 567-8680 Japan, Natsuko OKUMURA, a Japanese citizen, residing at 1-1-2, Shimohozumi, Ibaraki-shi, Osaka 567-8680 Japan, Michirou KAWANISHI, a Japanese citizen, residing at 1-1-2, Shimohozumi, Ibaraki-shi, Osaka 567-8680 Japan have invented certain new and useful improvements in a

Tape-Shaped Insulating Material, Insulated Product and
Aqueous Dispersion Type Acrylic Pressure-Sensitive Adhesive for Insulating Material

for which I have executed an application for Letters Patent in the United States, even date herewith;

AND WHEREAS, Nitto Denko Corporation (hereinafter "ASSIGNEE"), a Japanese Corporation, with its principal place of business at 1-1-2, Shimohozumi, Ibaraki-shi, Osaka 567-8680 Japan, desires to acquire the entire right, title, and interest in and to the said improvements and the said Application:

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, we the said inventors, do hereby acknowledge that we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under the said improvements, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

This 20th day of January, 2004

Mitsuyoshi Shirai
Mitsuyoshi SHIRAI

This 20th day of January, 2004

Natsuko Okumura
Natsuko OKUMURA

This 20th day of January, 2004

Michiro Kawanishi
Michiro KAWANISHI

Application No.:

Filing Date:

ASSIGNMENT

WHEREAS, We, Mitsuyoshi SHIRAI, a Japanese citizen, residing at 1-1-2, Shimohozumi, Ibaraki-shi, Osaka 567-8680 Japan, Natsuko OKUMURA, a Japanese citizen, residing at 1-1-2, Shimohozumi, Ibaraki-shi, Osaka 567-8680 Japan, Michirou KAWANISHI, a Japanese citizen, residing at 1-1-2, Shimohozumi, Ibaraki-shi, Osaka 567-8680 Japan have invented certain new and useful improvements in a

Tape-Shaped Insulating Material, Insulated Product and
Aqueous Dispersion Type Acrylic Pressure-Sensitive Adhesive for Insulating Material

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AND WHEREAS, Nitto Denko Corporation (hereinafter "ASSIGNEE"), a Japanese Corporation, with its principal place of business at 1-1-2, Shimohozumi, Ibaraki-shi, Osaka 567-8680 Japan, desires to acquire the entire right, title, and interest in and to the said improvements and the said Application:

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, we the said inventors, do hereby acknowledge that we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under the said improvements, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

This 20th day of January, 2004

Mitsuyoshi Shirai
Mitsuyoshi SHIRAI

This 20th day of January, 2004

Natsuko Okumura
Natsuko OKUMURA

This 20th day of January, 2004

Michirou Kawanishi
Michirou KAWANISHI